

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No.: Unknown
Filed: Herewith
Inventor(s):
Davidson

Title: CARBON FOAM HEAT
EXCHANGER FOR
INTEGRATED CIRCUIT

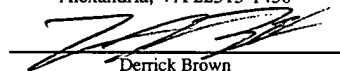
§ Examiner: Unknown
§ Group/Art Unit: Unknown
§ Atty. Dkt. No: 5181-83401
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Derrick Brown

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313

Sir:

It is respectfully requested that this Information Disclosure Statement be entered and the documents listed on attached Form PTO-1449 be considered by the Examiner and made of record. The references listed on the Form PTO-1449 were previously cited in U.S. Patent Application Serial No. 10/094,459 to which the captioned application is seeking priority under 35 U.S.C. § 120; therefore, a copy of each reference is not enclosed.

Inventor: Davidson
Appl. Ser. No.: Unknown
Atty. Dkt. No.: 5181-83400

Should any fees be required, the Commissioner is authorized to charge said fees to Meyertons, Hood, Kivlin, Kowert & Goetzel, P.C. Deposit Account No. 50-1505/5181-83401/EBM.

Respectfully submitted,



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Date: 6/20/2023

| Form PTO-1449 (modified) List of Patents and Publications For Applicant's Information Disclosure Statement (Use several sheets if necessary) | | | ATTY. DKT. NO. 5181-83401 APPLICANT: Howard L. Davidson FILING DATE: Herewith | | SERIAL NO. Unknown GROUP: Unknown | | |
|---|--------------|---|---|------------------|--|--------------|-------------------------------|
| U.S. PATENT DOCUMENTS | | | | | | | |
| EXAM. INITIALS | REF. DES. | DOCUMENT NUMBER | DATE | NAME | CLASS | SUB CLASS | FILING DATE IF APPROPRIATE |
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| | A2 | 5,300,272 | 04/1994 | Simandl et al. | | | |
| | A3 | 5,484,964 | 01/1996 | Dawson et al. | | | |
| | A4 | 5,783,316 | 07/1998 | Colella et al. | | | |
| | A5 | 6,011,313 | 01/2000 | Shangguan et al. | | | |
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| | A12 | 6,198,143 | 03/2001 | Ohsaki et al. | | | |
| OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.) | | | | | | | |
| | A13 | Harish Mavoori, Ainissa G. Ramirez, and Sungho Jin, "Universal solders for direct and powerful bonding on semiconductors, diamond, and optical materials" Appl. Phys. Lett. 78(19), May 2001, pp 2976-2978. | | | | | |
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EXAMINER:

DATE CONSIDERED:

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the patent owner.

Information Disclosure Statement--PTO 1449 (modified)